

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	2	US-20070161159-\$. DID.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/11/26 15:23
S7	8	US-20010015256-A1. DID. OR US- 20010053559-A1.DID. OR WO-2003010825-A1. DID. OR WO- 20000511181-A1.DID. OR EP-119379-\$.DID. OR JP-2003203898-\$. DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 08:43
S8	0	WO-2003010825-A1. DID. OR WO- 20000511181-A1.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 08:45
S9	2	"7452786".PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:28
S10	2	"7271076".PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:33
S11	39	["20010015256" "20010053559" "20020090765" "20030022403" "20030032210" "20040087110" "20040256618" "20050037529" "20050042798" "20050095760" "20050148121" "5206749" "5317236" "5376561" "5378536" "5389438" "5757456" "5821138" "5834327" "5888858" "5985740" "6043800" "6063654" "6100562" "6118502" "6165824"	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:33

		"6168829" "6180439" "6348368" "6376333" "6465287" "6479333" "6781152" "6893503" "7045438" "7056381" "7122445" "7129145").PN. OR ("7271076").URPN.				
S12	8	("20010015256" "20010053559" "20030022403" "20030032210" "20040087110" "20040256618" "20050148121" "7091070").PN. OR ("7452786").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:34
S13	412	KONDO-TAKAYUKI.IN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:37
S14	51591	sacrificial	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:38
S15	31	S13 and S14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:38
S16	12	("5073230" "5286335" "5391257" "5401983" "5465009" "5827751" "6033995" "6214733"). PN. OR ("6858518"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:44
S17	13	("4356429" "4539507" "5073230" "5286335" "5300788" "5391257" "5401983" "5465009" "5827751" "6033995" "6214733" "6291266").PN. OR ("7244662").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:45
S18	10	("20010015256" "20030022403" "20050051872" "20050106839" "6887650" "7060153"). PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:54

S19	2	US-20050106839-A1. did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:59
S20	18	("20010053559" "20030032210" "20040087110" "20040256618" "20050148121" "20050287846" "5378536" "5389438" "6168829").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:08
S21	91	("20030006121" "20040016115" "20040026520" "20050037529" "20050042798" "20050116048" "20070063057" "20070166954" "20080009125" "5206749" "5317236" "5376561" "5541399" "5757456" "5821138" "5834327" "5888858" "5985740" "6043800" "6063654" "6100562" "6118502" "6127199" "6165824" "6180439" "6348368" "6376333" "6465287" "6479333" "6521511" "6627518" "6700631" "6781152" "6814832" "6821553" "6825072" "6858518" "6893503" "6911358" "7045438" "7056381" "7091070" "7122445" "7129145" "7159241" "7166500" "7244662" "7271076").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:15
S22	56	S11 OR S12 OR S16 OR S17	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:44

S23	10860156	separa\$6 or remov\$6 or releas\$6 or sacrific\$6 or delaminat\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:45
S24	55	S22 AND S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:46
S25	853924	etch\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:59
S26	8878020	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:59
S27	1268143	(thin film transistor) or "TFT" or "IDF" or chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:00
S28	10036	S27 SAME S25 SAME S26 SAME S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S29	2687	438/149.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S30	4085	257/347.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S31	0	257/E27.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S32	6436	S27 SAME (S25 WITH S26) SAME S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:02

S33	526166	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S34	421	S32 AND S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S35	53	S32 SAME S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S36	79	S28 SAME S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S37	20	("20010015256" "20010053559" "20030022403" "20030032210" "20030071953" "20040087110" "20040219762" "20040256618" "20050070038" "20050148121" "20050285231" "5328868" "5665607" "5757456" "6118502" "6127199" "6372608" "6645830" "6818530" "RE38466").PN. OR ("7482248").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:10
S38	25	("20010012667" "20010015256" "20010053559" "20020000629" "20030022403" "20030024898" "20030032210" "20030071953" "20030157783" "20040087110" "20040219762" "20040256618" "20050070038" "20050148121" "5273609" "5324683" "5757456" "6118502" "6127199" "6372608"	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:11

		"6645830" "6787440" "6818530" "6982209" "RE38466").PN. OR ("7465674").URPN.				
S39	12	("20040217431" "20060055314" "20060121694" "20060244063" "20060246633" "20060246644" "20060246738" "20060270066" "4727044" "5757456" "6127199" "6975018").PN. OR ("7364954").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:11
S40	45	("20010015256" "20010053559" "20020030189" "20030022403" "20030030689" "20030032210" "20030169204" "20040128246" "20040129450" "20040129960" "20040132265" "20050023525" "20050045729" "20050051870" "20050070038" "20050130389" "20050148121" "20050168339" "20050192129" "20050210302" "20050214984" "20050287846" "20060068536" "20060099738" "20060177972" "5166556" "5198831" "5403700" "5581385" "5757456" "5821138" "5834327" "6022792" "6118502" "6372608" "6377176" "6478229" "6509217" "6682963" "6781152" "6998282" "7045438" "7109071" "7122445" "7282380"). PN. OR ("7368318"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:15

S41	74	S37 or S38 or S39 or S40	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:19
S42	16	S41 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:19
S43	202	S29 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:19
S44	121	S30 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:20
S45	10860156	separa\$6 or remov\$6 or releas\$6 or sacrific\$6 or delaminat\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S46	853924	etch\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S47	8878020	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S48	1268143	(thin film transistor) or "TFT" or "IDF" or chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S49	10036	S48 SAME S46 SAME S47 SAME S45	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25

S50	20	("20010015256" "20010053559" "20030022403" "20030032210" "20030071953" "20040087110" "20040219762" "20040256618" "20050070038" "20050148121" "20050285231" "5328868" "5665607" "5757456" "6118502" "6127199" "6372608" "6645830" "6818530" "RE38466").FN. OR ("7482248").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25
S51	25	("20010012667" "20010015256" "20010053559" "20020000629" "20030022403" "20030024898" "20030032210" "20030071953" "20030157783" "20040087110" "20040219762" "20040256618" "20050070038" "20050148121" "5273609" "5324683" "5757456" "6118502" "6127199" "6372608" "6645830" "6787440" "6818530" "6982209" "RE38466").FN. OR ("7465674").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25
S52	12	("20040217431" "20060055314" "20060121694" "20060244063" "20060246633" "20060246644" "20060246738" "20060270066" "4727044" "5757456" "6127199" "6975018").FN. OR ("7364954").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25

S53	45	("20010015256" "20010053559" "20020030189" "20030022403" "20030030689" "20030032210" "20030169204" "20040128246" "20040129450" "20040129960" "20040132265" "20050023525" "20050045729" "20050051870" "20050070038" "20050130389" "20050148121" "20050168339" "20050192129" "20050210302" "20050214984" "20050287846" "20060068536" "20060099738" "20060177972" "5166556" "5198831" "5403700" "5581385" "5757456" "5821138" "5834327" "6022792" "6118502" "6372608" "6377176" "6478229" "6509217" "6682963" "6781152" "6998282" "7045438" "7109071" "7122445" "7282380"). PN. OR ("7368318"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25
S54	74	S50 or S51 or S52 or S53	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S55	16	S54 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S56	16	S55	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25

S57	2687	438/149.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S58	202	S57 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S59	202	S58	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S60	4085	257/347.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S61	121	S60 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S62	121	S61	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S63	4	S55 NOT ("semiconductor energy laboratory")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:28
S64	170	S58 NOT ("semiconductor energy laboratory")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:28
S65	103	S61 NOT ("semiconductor energy laboratory")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S66	85	S65 not S64	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29

S67	526166	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S68	526166	S67	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S69	255	S64 OR S66	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S70	7	S69 AND S67	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:30
S71	2721344	(thin film transistor) or "TFT" or "IDF" or chip or "IC" or (integrated circuit)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:10
S72	526166	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:10
S73	3277701	dice or dicing or cut or cutting or scribe or scribing	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:10
S74	118259	(anisotropic NEAR2 conductor) or (ultrasonic NEAR2 adhesive) or ((ultraviolet or "UV" or curing) NEAR2 resin)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:12
S75	8502615	droplet or sputter\$4 or print\$4 or plat\$4 or lithograph\$6 or evaporat \$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13
S76	89	S72 SAME S74 SAME S75	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13

S77	36	S76 AND S71	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13
S78	17	S77 AND S73	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13
S79	18	S76 SAME S71	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:31
S80	62	S76 NOT (S78 OR S79)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:39
S81	9	S80 AND S71	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:39
S82	19	("20010002874" "20010044013" "4483067" "4960983" "5048179" "5308967" "5399847" "5424527" "5598032" "5710458" "5837992" "5852289" "5856662" "6049461" "6160526" "6176010" "6392297").PN. OR ("7129145").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 15:59
S83	40385	S71 SAME S72	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 16:30
S84	22704	S71 WITH S72	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 16:30
S85	5014	S71 NEAR S72	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 16:31
S86	2687	438/149.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31

S87	4085	257/347.CQLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31
S88	6392	S86 OR S87	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31
S89	24	S85 AND S88	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31
S90	2	"6927108".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:49
S91	118372	(anisotropic NEAR2 conductor) or (ultrasonic NEAR2 adhesive) or ((ultraviolet or "UV" or curing) NEAR2 resin)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:24
S92	526638	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:25
S93	2722924	(thin film transistor) or "TFT" or "IDF" or chip or "IC" or (integrated circuit)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:25
S94	81	S91 SAME S92 SAME S93	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:26
S95	8019	yamazaki-shunpei.in. or dairiki-koji.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:27
S96	8881152	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:27

S97	10865419	separa\$6 or remov\$6 or releas\$6 or sacrific\$6 or delaminat\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:28
S98	228902	S93 SAME S96 SAME S97	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:28
S99	1150	S98 SAME S92	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S100	309	S95 AND S98	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S101	30	S95 AND S99	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S102	854518	etch\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S103	20452	S93 SAME S96 SAME S97 same S102	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30
S104	20452	S103 same S102	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30
S105	184	S95 and S103	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30
S106	101	S103 same S92	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30

S107	24	S95 and S106	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:31
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